

# 1.0A Surface Mount Ultra Fast Rectifiers -600V

#### **Features**

- Ideal for surface mounted application
- Low profile surface mounted application in order to optimize board space
- Bulit-in strain relief design
- Ultra fast recovery time for high efficient
- Glass passivated chip junction
- Lead-free parts meet RoHS requirements
- Compliant to Halogen-free

#### Mechanical data

• Epoxy:UL94-V0 rated flame retardant

• Case: Molded plastic, SMA(DO-214AC)

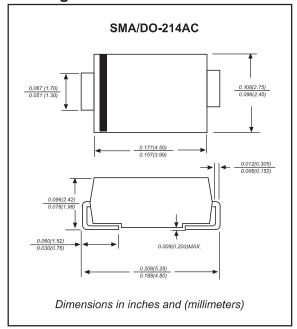
• Terminals : Solder plated, solderable per

MIL-STD-750, Method 2026

• Polarity : Indicated by cathode band

• Mounting Position : Any

#### Package outline



#### **Maximum ratings** (AT T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOLS	STTH1L06A	UNITS
Maximum repetitive peak reverse voltage	VRRM	600	V
Maximum RMS voltage	VRMS	420	V
Maximum continuous reverse voltage	VR	600	V
Maximum average forward rectified current	lo	1.0	Α
Non-repetitive peak forward surge current 8.3ms single half sine-wave	IFSM	35	А
Typical junction capacitance (Note 1)	CJ	15	pF
Operating junction temperature range	TJ	-55 to +175	°C
Storage temperature range	Тѕтс	-65 to +175	°C

#### Electrical characteristics (AT T<sub>a</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOLS	STTH1L06A	UNITS
Maximum instantaneous forward voltage at IF=1.0A TJ=25 °C	VF	1.25	V
Maximum instantaneous forward voltage at IF=1.0A TJ=150°C	VF	1.05	V
Maximum reverse leakage current T <sub>J</sub> =25 °C at rated V <sub>R</sub> T <sub>J</sub> =125 °C	lr	1.0 150	μA
Maximum reverse recovery time, (Note 2)	trr	50	ns

#### Thermal characteristics

PARAMETER	SYMBOLS	STTH1L06A	UNITS
Typical thermal resistance junction to ambient , (Note 3) Typical thermal resistance junction to case , (Note 3)	Reja	25	°C/W
	Rejc	15	°C/W

Notes 1: Measured at 1 MHz and applied reverse voltage of 4.0 VDC

2: Measured with IF = 0.5 A, IR = 1 A, Irr = 0.25 A

<sup>3:</sup> Mounted on FR-4 PCB Copper, minimum recommended pad layout

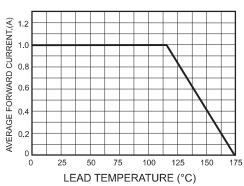


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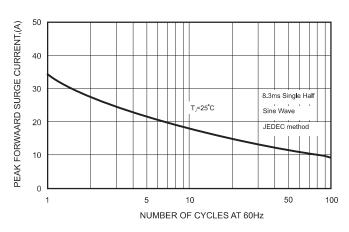
#### Rating and characteristic curves

FIG.1-TYPICAL FORWARD **CHARACTERISTICS** INSTANTANEOUS FORWARD CURRENT,(A) 10 1 0.1 0.01 0.001 0.2 0.4 0.6 0.8 1.2 1.4 1,6 1.8 FORWARD VOLTAGE,(V)

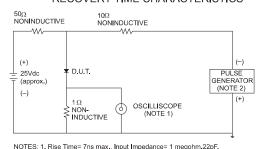
#### FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE



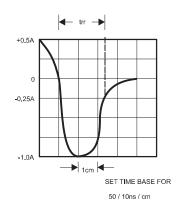
## FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



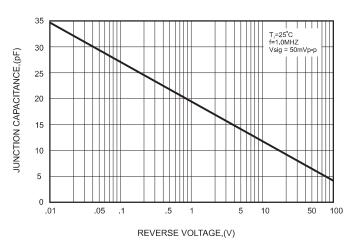
# FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= /ns max., Input Impedance= 1 megohm.22pr 2. Rise Time= 10ns max., Source Impedance= 50 ohms.



#### FIG.5-TYPICAL JUNCTION CAPACITANCE





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## Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode	1 [ 2	1 2

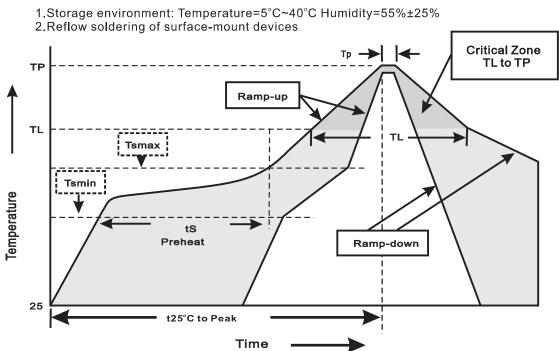
### Marking

Type number	Marking code
STTH1L06A	HL6



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#### Suggested thermal profiles for soldering processes



#### 3.Reflow soldering

Profile Feature	Soldering Condition
Average ramp-up rate(TL to TP)	<3°C/sec
Preheat -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(min to max)(t <sub>s</sub> )	150°C 200°C 60~120sec
Tsmax to T∟ -Ramp-upRate	<3°C/sec
Time maintained above: -Temperature(TL) -Time(tL)	217°C 60~260sec
Peak Temperature(T <sub>P</sub> )	255°C-0/+5°C
Time within 5°C of actual Peak Temperature(t <sub>P</sub> )	10~30sec
Ramp-down Rate	<6°C/sec
Time 25°C to Peak Temperature	<6minutes